TA1K&TA2K

High Wattage Heat Sinkable Planar Resistor

The TAP series delivers 1000W or 2000W of continuous power when properly mounted to a liquid cooled heat sink (based on 85°C mounting plate temperature). Applications include power conditioning, power distribution, power conversion, and power control.





FEATURES

- High Energy Rating
- Low Inductance
- Resistor Element Electrically Isolated
- High Dielectric Strength
- Small Footprint

APPLICATIONS

- Power semiconductor balancing
- Motor control
- Inrush Current Limiting

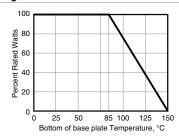
CHARACTERISTICS

Resistor Element	Thick Film on Alumina Substrate		
Power Rating	1000W or 2000W at 85°C mounting plate		
Resistance Values	0.5Ω to 1000Ω		
Resistance Tolerance	+10% std.		
Max Operating Voltage	2000VDC		
Temperature Coefficient	± 250 PPM/°C		
Dielectric Strength	6KV standard		
Operating Temperature Range	-55°C to 85°C		
Terminal Screws	#10-32		
Max Contacts Torque	10 in-lb		
Mounting Screws	#8-32		
Max Mounting Torque	15 in-lb		
Creepage Distance	50mm ± 1mm (min)		

		Rating		
Test		Continuous	Pulse	
	Rated Power, max. current and heat sink plate	(TA1K0) 1000W		
	temperature limited	(TA2K0) 2000W		
	Operating Voltage	√P*R	N/A	
	Max. Applied Voltage, ohms law limited	223V	2000VDC	
	Max. Current	10A	53.33A	
	Critical Resistance; below this resistance max	(TA1K0) 10Ω	7	
	power has to be de-rated due to exceeding max	(TA2K0) 20Ω		
	current			

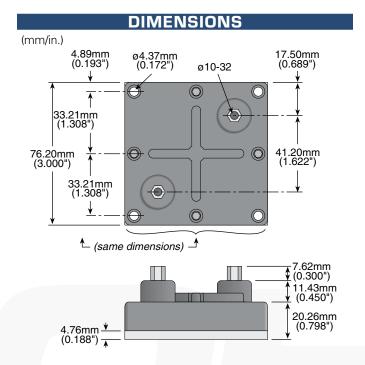
Test	Method	Maximum ΔR
Short Time Overload	1.14 x √P*R / 10 sec @ 70°C	Max % Δ Rsto = ±(2% + 0.05Ω)
	(TA1K0) 1000 hrs @ 40°C, 90-95% RH (TA2K0) 1750 hrs @ 40°C, 90-95% RH	≤1% ≤1%
Thermal Shock	MIL-STD-202, Method 107	MIL-STD-202, Method 107
Vibration, elec.	MIL-STD-202, Method 201	±2% Resistance
Vibration, mech.	MIL-STD-202, Method 201	No Loose Terminal Screws
Load Life	(TA1K0) 1000 Hrs 90 min ON / 30 min OFF (TA2K0) 1750 Hrs 90 min ON / 30 min OFF	≤1% ≤1%
Pulse Tolerance	52μF @ 2KV / 60 sec intervals, 104J, 20,000 Pulses	≤1%
Dielectric Strength	Dielectric 6KVDC for 1 minute Strength	

Derating



TA1K&TA2K

High Wattage Heat Sinkable Planar Resistor



APPLICATION NOTES

Proper heat sinking techniques are essential to performance of a TAP resistor. Pleased follow these guidelines when designing TAP system:

- Heats sink plate (base plate of the resistor) temperature must be monitored to establish proper de-rating. Best technique is to attach a thermocouple to the side of the base plate of the resistor. Temperature of plastic housing or heat sink cannot be used to establish rating of the resistor. Usage of laser thermometers should be avoided.
- To obtain a power rating of 1000W or 2000W, the bottom case temp must not exceed 85°C. This can only be achieved if the thermal conduction to the heatsink Rth-cs<0.025°K/W. This value can be reached by using thermal transfer compound with a heat conductivity of 1W/mK. The flatness of the cooling plate must be better than 0.05mm overall. The roughness of the surface should not exceed 6.4µm.
- Due to very high power density, only liquid cooled heat sinks are recommended for applications when >300W power rating is desired.
- Properly designed heat sink should have more than 2 cooling pipes under the surface of the TAP resistor. The Ohmite CP4 heat sink (https://www.ohmite.com/cp4-series-chillplate/) is an example of properly designed heat sink.

ORDERING INFORMATION

RoHS Compliant

Standard Part Numbers

Ohms	1000 Watt 10% Tolerance	Ohms	2000 Watt 10% Tolerance
0.5 1 2.5 5	TA1K0PHR500KE TA1K0PH1R00KE TA1K0PH2R50KE TA1K0PH5R00KE TA1K0PH7R50KE	 0.5 1 2.5 5 7.5	TA2K0PHR500KE TA2K0PH1R00KE TA2K0PH2R50KE TA2K0PH5R00KE TA2K0PH7R50KE
7.5 10 15 25 50 100	TA1K0PH7R50KE TA1K0PH15R0KE TA1K0PH25R0KE TA1K0PH50R0KE TA1K0PH100RKE	 10 15 25 50 100	TA2K0PH7H30KE TA2K0PH10R0KE TA2K0PH15R0KE TA2K0PH25R0KE TA2K0PH50R0KE TA2K0PH100RKE
250 500 750 1000	TA1K0PH250RKE TA1K0PH500RKE TA1K0PH750RKE TA1K0PH1K00KE	 250 500 750 1000	TA2K0PH250RKE TA2K0PH500RKE TA2K0PH750RKE TA2K0PH1K00KE

